

- High Efficiency . . . 60% or Greater
- Peak Switch Current . . . 500 mA
- Input Current Limit Protection
- TTL-Compatible Inhibit
- Adjustable Output Voltage
- Input Regulation . . . 0.2% Typ
- Output Regulation . . . 0.4% Typ
- Soft Start-Up Capability
- Can be Used in Buck, Boost, and Inverting Configurations

description/ordering information

The TL497A incorporates all the active functions required in the construction of switching voltage regulators. It also can be used as the control element to drive external components for high-power-output applications. The TL497A was designed for ease of use in step-up, step-down, or voltage-inversion applications requiring high efficiency.

The TL497A is a fixed-on-time variable-frequency switching-voltage-regulator control circuit. The switch-on time is programmed by a single external capacitor connected between FREQ CONTROL and GND. This capacitor, C_T , is charged by an internal constant-current generator to a predetermined threshold. The charging current and the threshold vary proportionally with V_{CC} . Thus, the switch-on time remains constant over the specified range of input voltage (4.5 V to 12 V). Typical on times for various values of C_T are as follows:

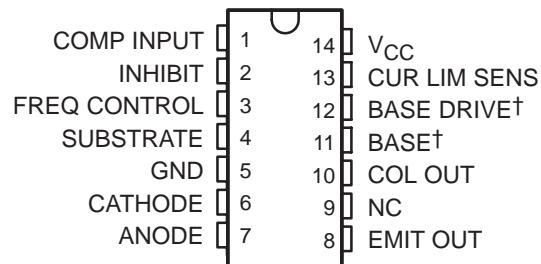
TIMING CAPACITOR, C_T (pF)	200	250	350	400	500	750	1000	1500	2000
ON TIME (μs)	19	22	26	32	44	56	80	120	180

The output voltage is controlled by an external resistor ladder network (R1 and R2 in Figures 1, 2, and 3) that provides a feedback voltage to the comparator input. This feedback voltage is compared to the reference voltage of 1.2 V (relative to SUBSTRATE) by the high-gain comparator. When the output voltage decays below the value required to maintain 1.2 V at the comparator input, the comparator enables the oscillator circuit, which charges and discharges C_T as described above. The internal pass transistor is driven on during the charging of C_T . The internal transistor can be used directly for switching currents up to 500 mA. Its collector and emitter are uncommitted, and it is current driven to allow operation from the positive supply voltage or ground. An internal Schottky diode matched to the current characteristics of the internal transistor also is available for blocking or commutating purposes. The TL497A also has on-chip current-limit circuitry that senses the peak currents in the switching regulator and protects the inductor against saturation and the pass transistor against overstress. The current limit is adjustable and is programmed by a single sense resistor, R_{CL} , connected between V_{CC} and CUR LIM SENS. The current-limit circuitry is activated when 0.7 V is developed across R_{CL} . External gating is provided by the INHIBIT input. When the INHIBIT input is high, the output is turned off.

Simplicity of design is a primary feature of the TL497A. With only six external components (three resistors, two capacitors, and one inductor), the TL497A operates in numerous voltage-conversion applications (step-up, step-down, invert) with as much as 85% of the source power delivered to the load. The TL497A replaces the TL497 in all applications.

The TL497AC is characterized for operation from 0°C to 70°C. The TL497AI is characterized for operation from -40°C to 85°C.

D, N, OR PW PACKAGE
(TOP VIEW)



NC – No internal connection

†BASE (11) and BASE DRIVE (12) are used for device testing only. They normally are not used in circuit applications of the device.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TL497A

500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

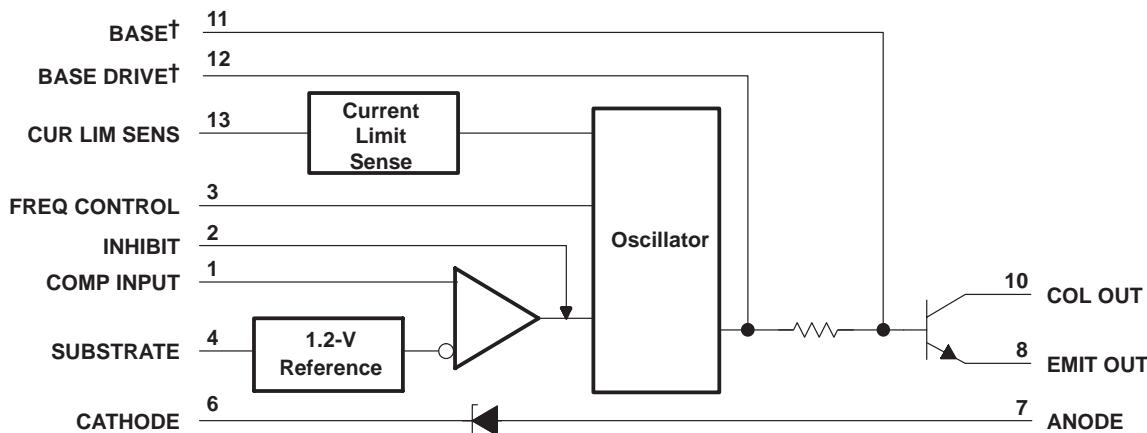
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AVAILABLE OPTIONS

TA	PACKAGED DEVICES			CHIP FORM (Y)
	SMALL-OUTLINE (D)	PLASTIC DIP (N)	SHRINK SMALL-OUTLINE (PW)	
0°C to 70°C	TL497ACD	TL497ACN	TL497ACPW	TL497AY
-40°C to 85°C	TL497AID	TL497AIN	—	—

The D and PW packages are only taped and reeled. Add the suffix R to the device type (e.g., TL497ACPWR). Chip forms are tested at 25°C.

functional block diagram



† BASE and BASE DRIVE are used for device testing only. They normally are not used in circuit applications of the device.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

[†]Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except diode voltages, are with respect to network ground terminal.

1. All voltage values, except diode voltages, are with respect to network ground terminal.
2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V_{CC}		4.5	12	V
High-level input voltage, V_{IH}	INHIBIT pin	2.5		V
Low-level input voltage, V_{IL}	INHIBIT pin		0.8	V
Output voltage	Step-up configuration (see Figure 1)		$V_I + 2$	30
	Step-down configuration (see Figure 2)		V_{ref}	$V_I - 1$
	Inverting regulator (see Figure 3)		$-V_{ref}$	-25
Power switch current		500		mA
Diode forward current		500		mA
Operating free-air temperature range, T_A		TL497AC	0	70
		TL497AI	-40	85
				°C

TL497A

500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

SLVS009F – JUNE 1976 – REVISED FEBRUARY 2005

electrical characteristics over recommended operating conditions, $V_{CC} = 6$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A [†]	TL497AC			TL497AI			UNIT
			MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
High-level input current, INHIBIT	$V_{I(I)} = 5$ V	Full range		0.8	1.5		0.8	1.5	mA
Low-level input current, INHIBIT	$V_{I(I)} = 0$ V	Full range		5	10		5	20	μ A
Comparator reference voltage	$V_I = 4.5$ V to 6 V	Full range	1.08	1.2	1.32	1.14	1.2	1.26	V
Comparator input bias current	$V_I = 6$ V	Full range		40	100		40	100	μ A
Switch on-state voltage	$V_I = 4.5$ V	$I_O = 100$ mA	25°C		0.13	0.2	0.13	0.2	V
		$I_O = 500$ mA	Full range		0.85			1	
Switch off-state current	$V_I = 4.5$ V, $V_O = 30$ V	25°C		10	50		10	50	μ A
		Full range			200			500	
Sense voltage, CUR LIM SENS	$V_I = 6$ V	25°C	0.45		1	0.45		1	V
Diode forward voltage	$I_O = 10$ mA	Full range		0.75	0.85		0.75	0.95	V
	$I_O = 100$ mA	Full range		0.9	1		0.9	1.1	
	$I_O = 500$ mA	Full range		1.33	1.55		1.33	1.75	
Diode reverse voltage	$I_O = 500$ μ A	Full range				30			V
	$I_O = 200$ μ A	Full range		30					
On-state supply current		25°C		11	14		11	14	mA
		Full range		15			16		
Off-state supply current		25°C		6	9		6	9	mA
		Full range		10			11		

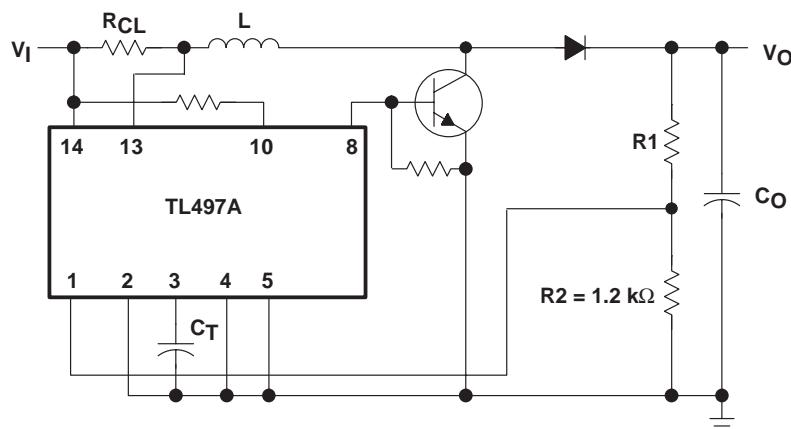
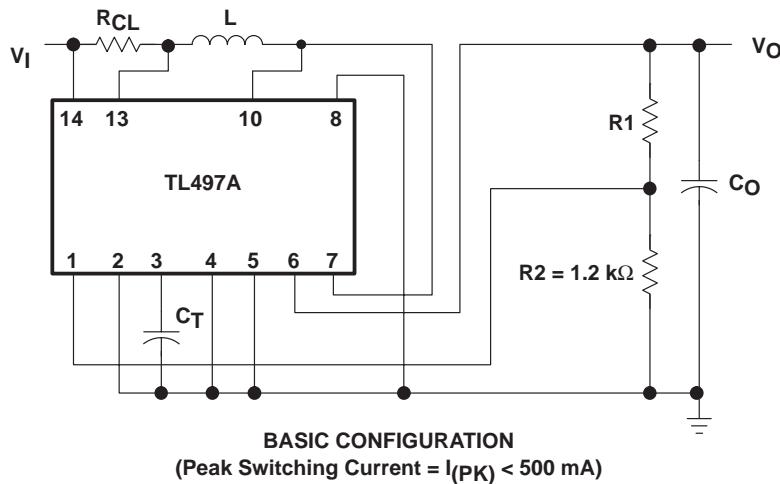
[†] Full range is 0°C to 70°C for the TL497AC and –40°C to 85°C for the TL497AI.

[‡] All typical values are at $T_A = 25$ °C.

electrical characteristics over recommended operating conditions, $V_{CC} = 6$ V, $T_A = 25$ °C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TL497AY			UNIT
		MIN	TYP	MAX	
High-level input current, INHIBIT	$V_{I(I)} = 5$ V		0.8		mA
Low-level input current, INHIBIT	$V_{I(I)} = 0$ V		5		μ A
Comparator reference voltage	$V_I = 4.5$ V to 6 V		1.2		V
Comparator input bias current	$V_I = 6$ V		40		μ A
Switch on-state voltage	$V_I = 4.5$ V, $I_O = 100$ mA		0.13		V
Switch off-state current	$V_I = 4.5$ V, $V_O = 30$ V		10		μ A
Diode forward voltage	$I_O = 10$ mA		0.75		V
	$I_O = 100$ mA		0.9		
	$I_O = 500$ mA		1.33		
On-state supply current			11		mA
Off-state supply current			6		mA

APPLICATION INFORMATION



DESIGN EQUATIONS

$$\bullet \quad I_{(PK)} = 2 I_{O \max} \left[\frac{V_O}{V_I} \right]$$

$$\bullet \quad L (\mu H) = \frac{V_I}{I_{(PK)}} t_{on} (\mu s)$$

Choose L (50 to 500 μ H), calculate
 t_{on} (25 to 150 μ s)

$$\bullet \quad C_T (\mu F) \approx 12 t_{on} (\mu s)$$

$$\bullet \quad R1 = (V_O - 1.2 V) k\Omega$$

$$\bullet \quad R_{CL} = \frac{0.5 V}{I_{(PK)}} \left[\frac{V_I}{V_O} I_{(PK)} + I_O \right]$$

$$\bullet \quad C_O (\mu F) \approx \frac{t_{on} (\mu s)}{V_{ripple} (PK)}$$

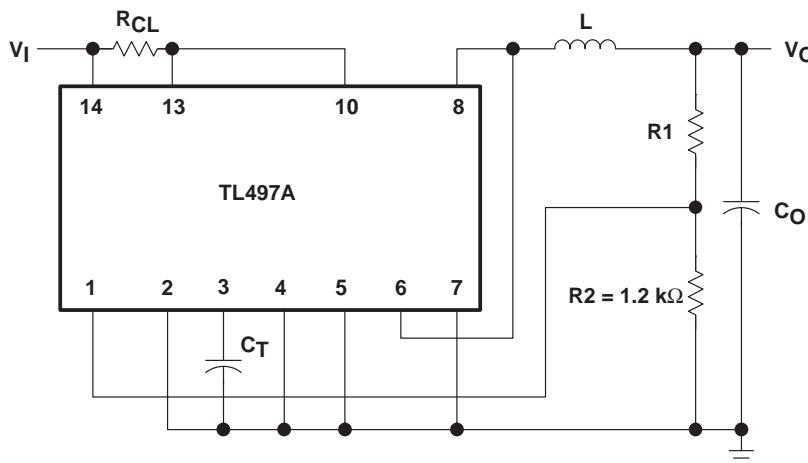
Figure 1. Positive Regulator, Step-Up Configurations

TL497A

500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

SLVS009F – JUNE 1976 – REVISED FEBRUARY 2005

APPLICATION INFORMATION



BASIC CONFIGURATION
(Peak Switching Current = $I_{(PK)} < 500$ mA)

DESIGN EQUATIONS

$$\bullet I_{(PK)} = 2 I_O \text{ max}$$

$$\bullet L (\mu\text{H}) = \frac{V_I - V_O}{I_{(PK)}} t_{on} (\mu\text{s})$$

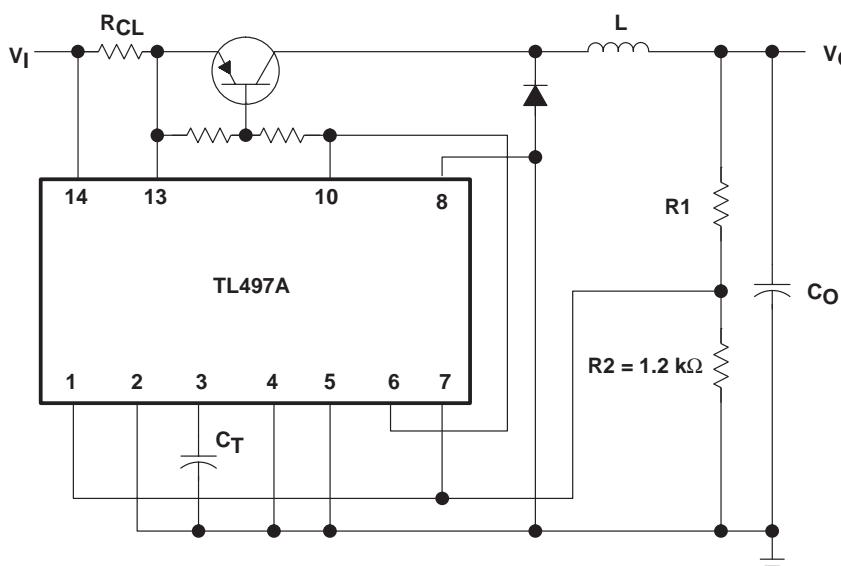
Choose L (50 to 500 μH), calculate
 t_{on} (10 to 150 μs)

$$\bullet C_T (\text{pF}) \approx 12 t_{on} (\mu\text{s})$$

$$\bullet R1 = (V_O - 1.2 \text{ V}) \text{ k}\Omega$$

$$\bullet R_{CL} = \frac{0.5 \text{ V}}{I_{(PK)}}$$

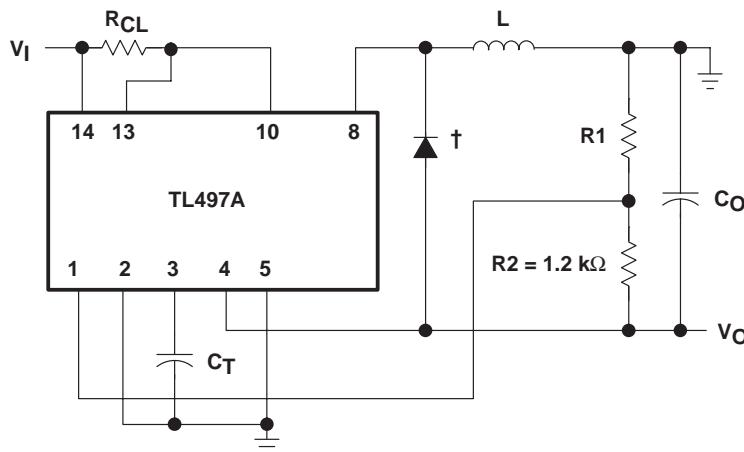
$$\bullet C_O (\mu\text{F}) \approx t_{on} (\mu\text{s}) \left[\frac{V_I - V_O}{V_O} I_{(PK)} + I_O \right] / V_{\text{ripple (PK)}}$$



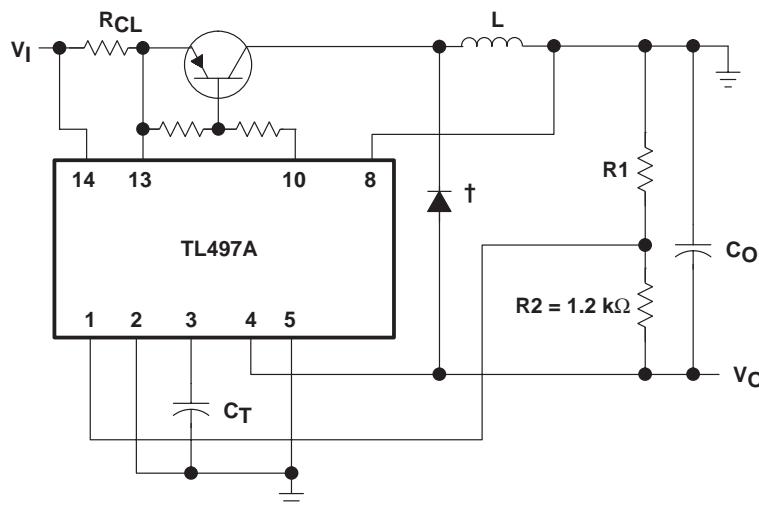
EXTENDED POWER CONFIGURATION
(using external transistor)

Figure 2. Positive Regulator, Step-Down Configurations

APPLICATION INFORMATION



BASIC CONFIGURATION
(Peak Switching Current = $I_{(PK)}$ < 500 mA)



EXTENDED POWER CONFIGURATION
(using external transistor)

† Use external catch diode, e.g., 1N4001, when building an inverting supply with the TL497A.

DESIGN EQUATIONS

$$\bullet \quad I_{(PK)} = 2 I_O \max \left[1 + \frac{|V_O|}{V_I} \right]$$

$$\bullet \quad L (\mu H) = \frac{V_I}{I_{(PK)}} t_{on} (\mu s)$$

Choose L (50 to 500 μH), calculate t_{on} (10 to 150 μs)

$$\bullet \quad C_T (pF) \approx 12 t_{on} (\mu s)$$

$$\bullet \quad R1 = (|V_O| - 1.2 V) k\Omega$$

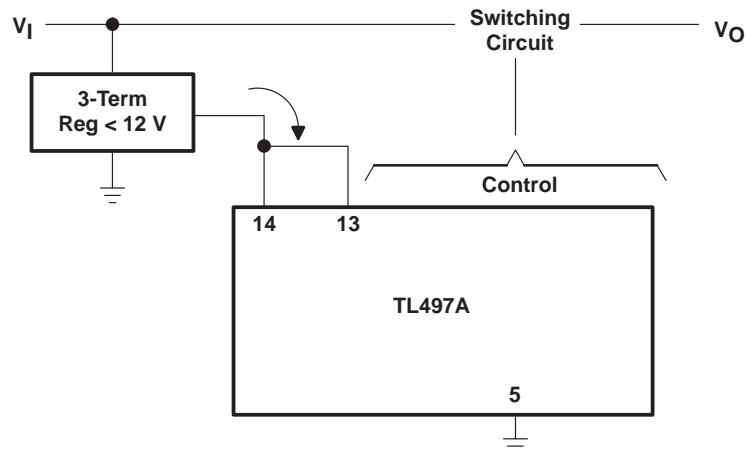
$$R_{CL} = \frac{0.5 V}{I_{(PK)}} \left[\frac{V_I}{|V_O|} I_{(PK)} + I_O \right]$$

$$\bullet \quad C_O (\mu F) \approx t_{on} (\mu s) \frac{V_{ripple} (PK)}{V_O}$$

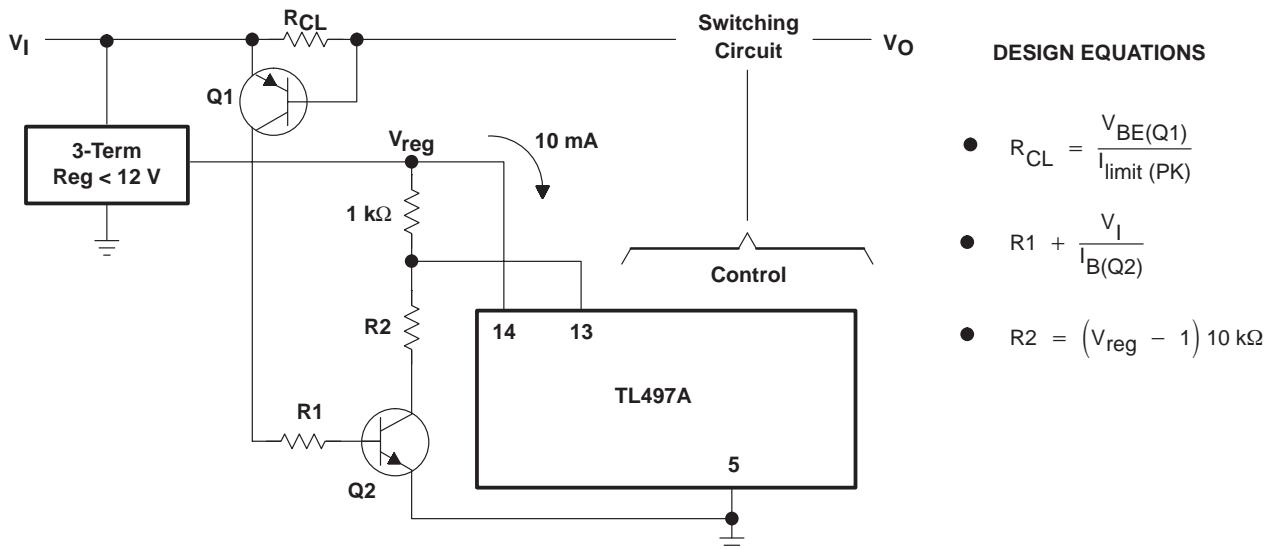
TL497A 500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

SLVS009F – JUNE 1976 – REVISED FEBRUARY 2005

APPLICATION INFORMATION



EXTENDED INPUT CONFIGURATION WITHOUT CURRENT LIMIT



CURRENT LIMIT FOR EXTENDED INPUT CONFIGURATION

Figure 4. Extended Input Voltage Range ($V_I > 12$ V)

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TL497ACD	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL497AC
TL497ACD.A	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AC
TL497ACDR	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL497AC
TL497ACDR.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AC
TL497ACN	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TL497ACN
TL497ACN.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TL497ACN
TL497ACNE4	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TL497ACN
TL497ACNSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL497A
TL497ACNSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497A
TL497ACPWR	Active	Production	TSSOP (PW) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	T497A
TL497ACPWR.A	Active	Production	TSSOP (PW) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	T497A
TL497AID	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AI
TL497AID.A	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AI
TL497AIDR	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AI
TL497AIDR.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL497AI
TL497AIN	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TL497AIN
TL497AIN.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TL497AIN

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

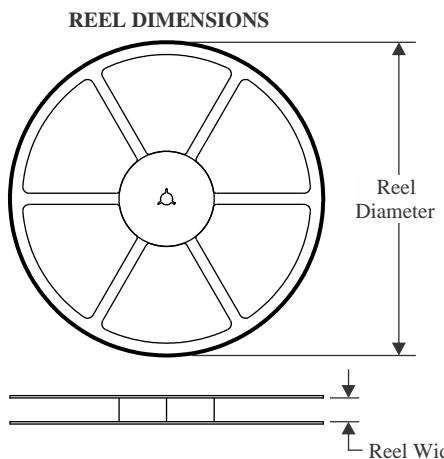
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

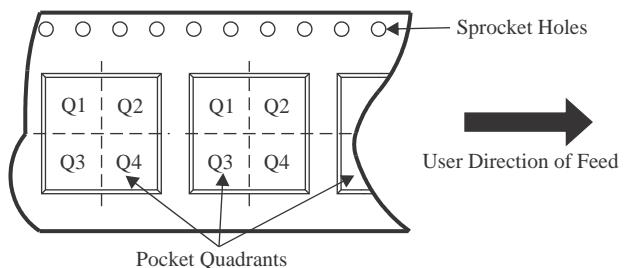
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


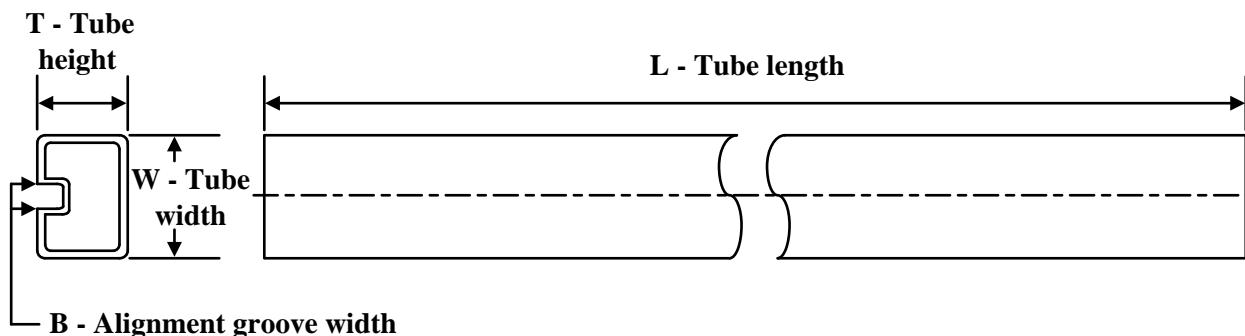
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL497ACDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TL497ACNSR	SOP	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
TL497ACPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TL497AIDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL497ACDR	SOIC	D	14	2500	340.5	336.1	32.0
TL497ACNSR	SOP	NS	14	2000	356.0	356.0	35.0
TL497ACPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
TL497AIDR	SOIC	D	14	2500	340.5	336.1	32.0

TUBE


*All dimensions are nominal

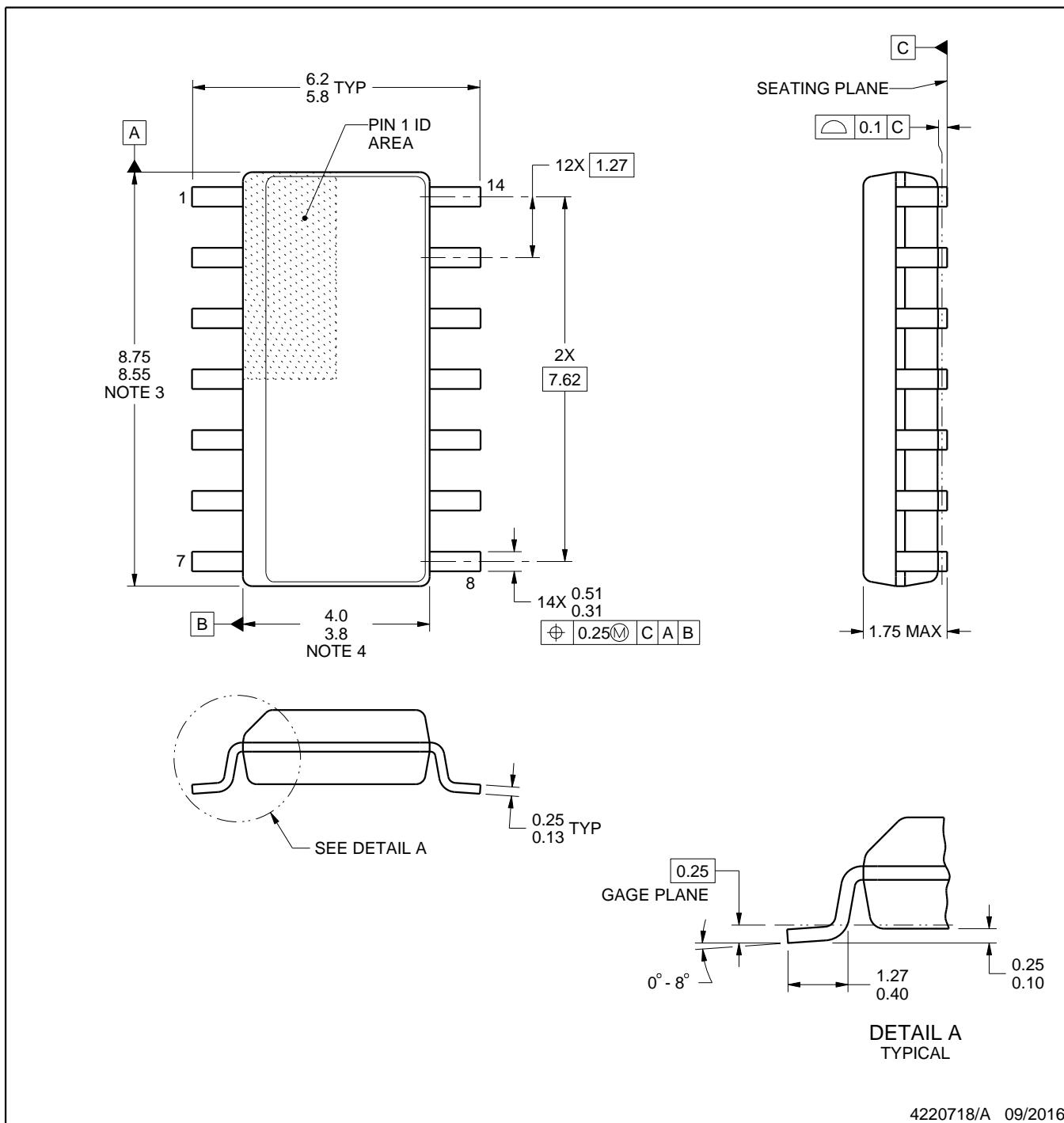
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TL497ACD	D	SOIC	14	50	507	8	3940	4.32
TL497ACD.A	D	SOIC	14	50	507	8	3940	4.32
TL497ACN	N	PDIP	14	25	506	13.97	11230	4.32
TL497ACN	N	PDIP	14	25	506	13.97	11230	4.32
TL497ACN.A	N	PDIP	14	25	506	13.97	11230	4.32
TL497ACN.A	N	PDIP	14	25	506	13.97	11230	4.32
TL497ACNE4	N	PDIP	14	25	506	13.97	11230	4.32
TL497ACNE4	N	PDIP	14	25	506	13.97	11230	4.32
TL497AID	D	SOIC	14	50	507	8	3940	4.32
TL497AID.A	D	SOIC	14	50	507	8	3940	4.32
TL497AIN	N	PDIP	14	25	506	13.97	11230	4.32
TL497AIN.A	N	PDIP	14	25	506	13.97	11230	4.32

PACKAGE OUTLINE

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

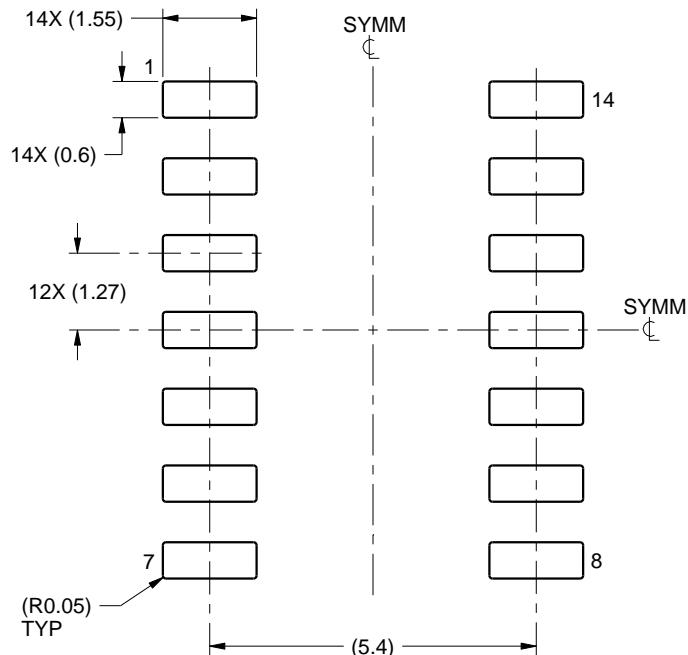
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

EXAMPLE BOARD LAYOUT

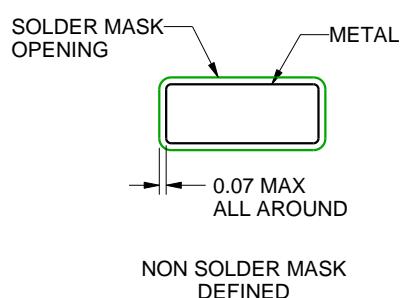
D0014A

SOIC - 1.75 mm max height

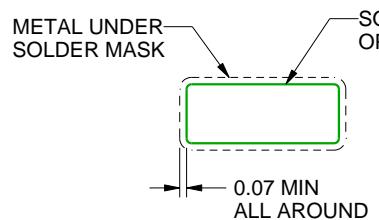
SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
SCALE:8X



NON SOLDER MASK
DEFINED



SOLDER MASK
DEFINED

SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

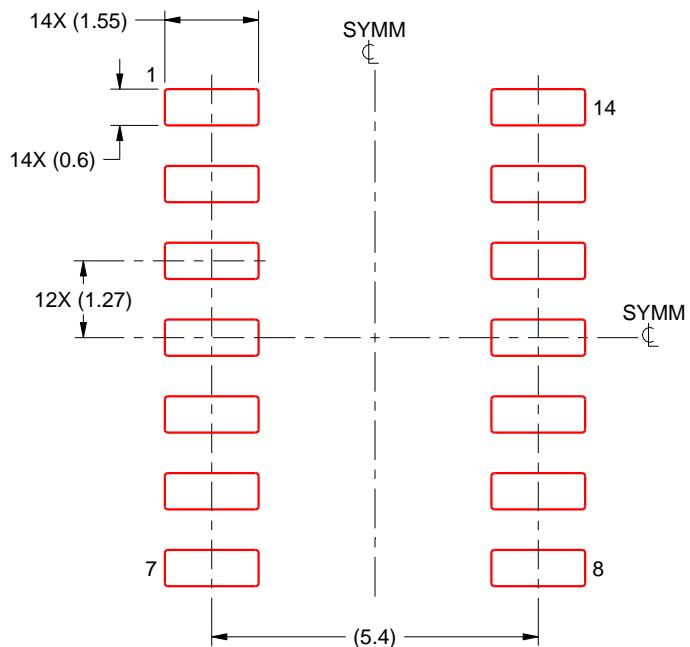
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

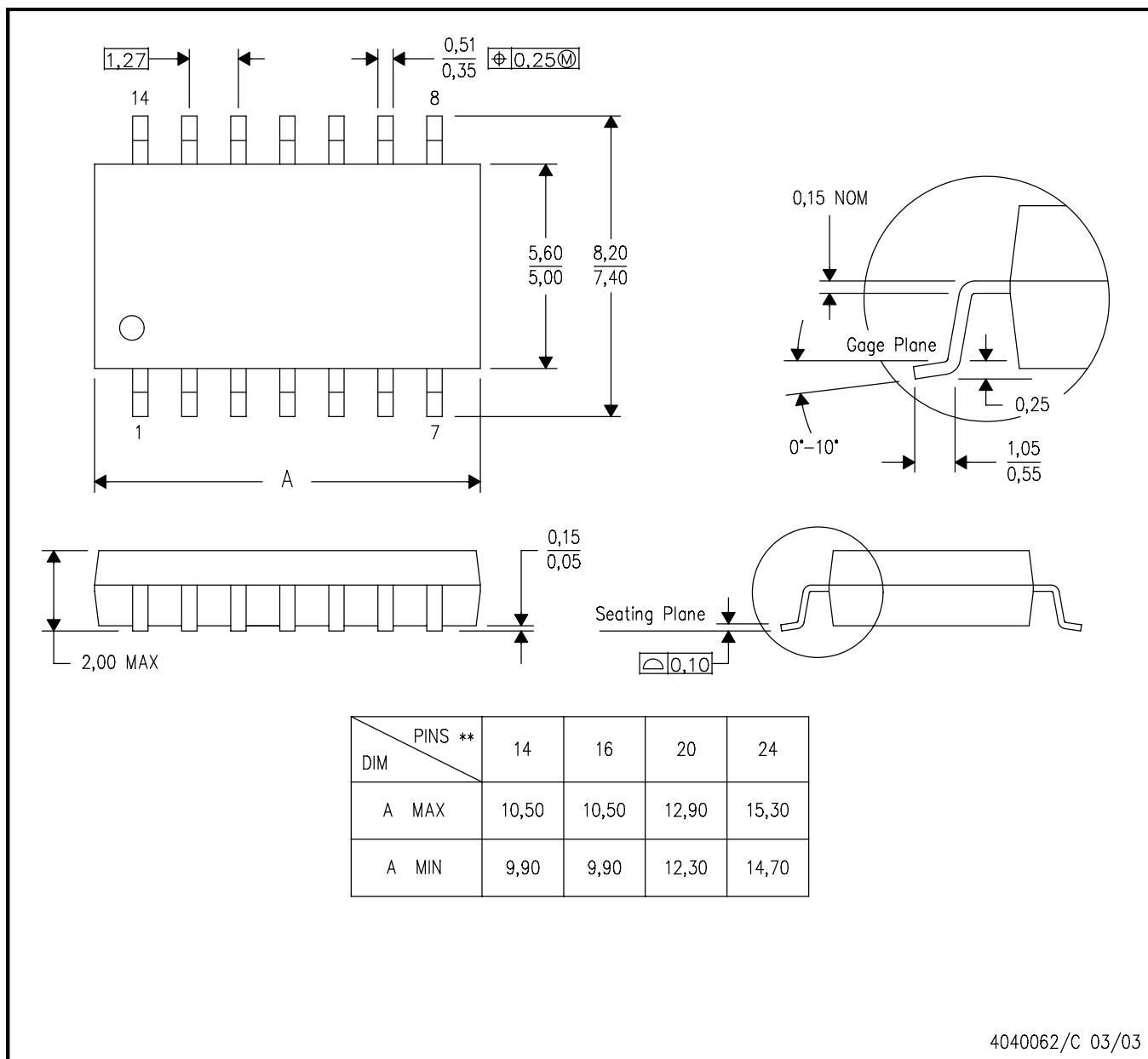
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



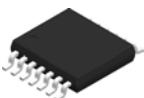
NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

△ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

△ The 20 pin end lead shoulder width is a vendor option, either half or full width.

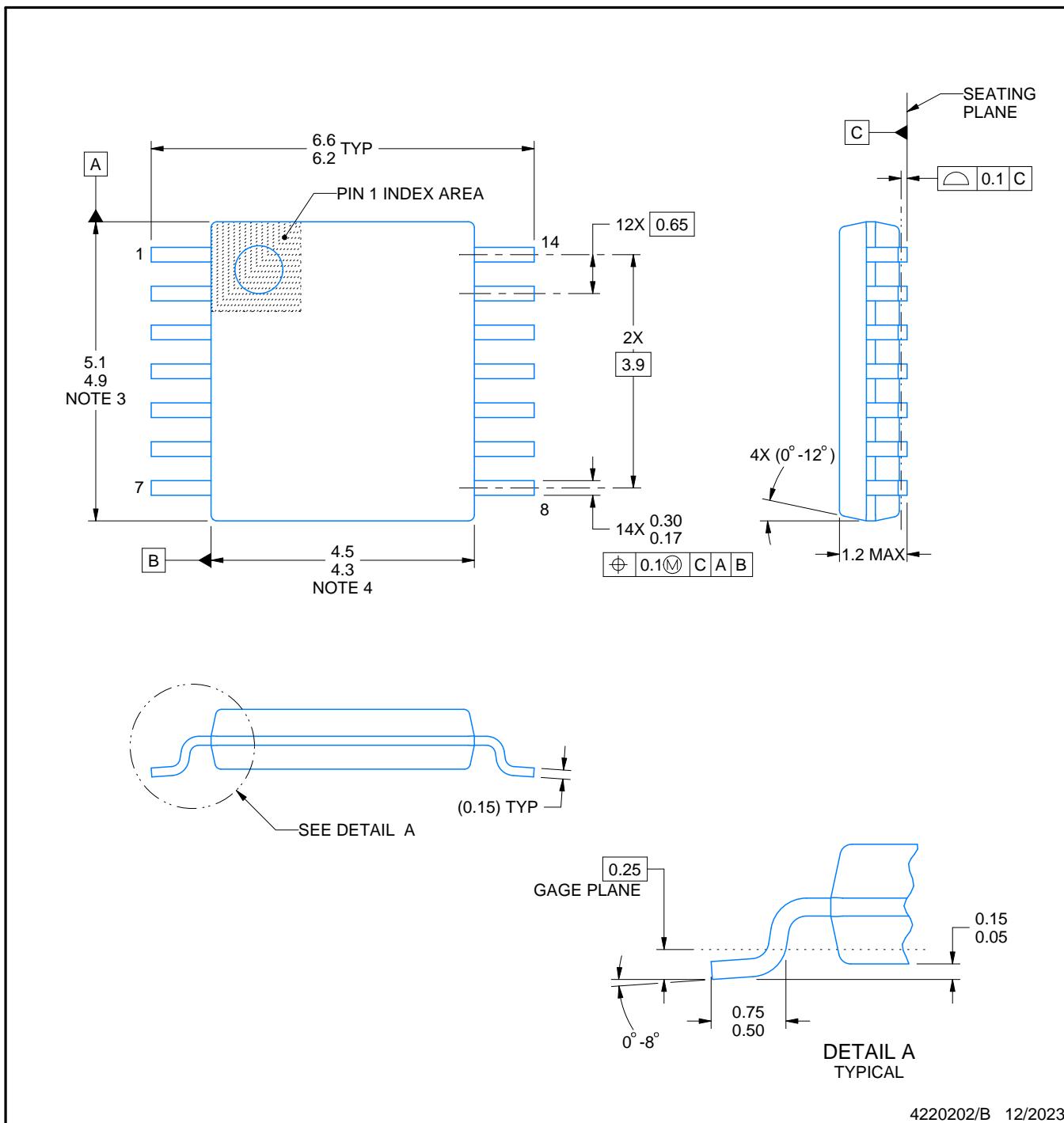
PACKAGE OUTLINE

PW0014A



TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

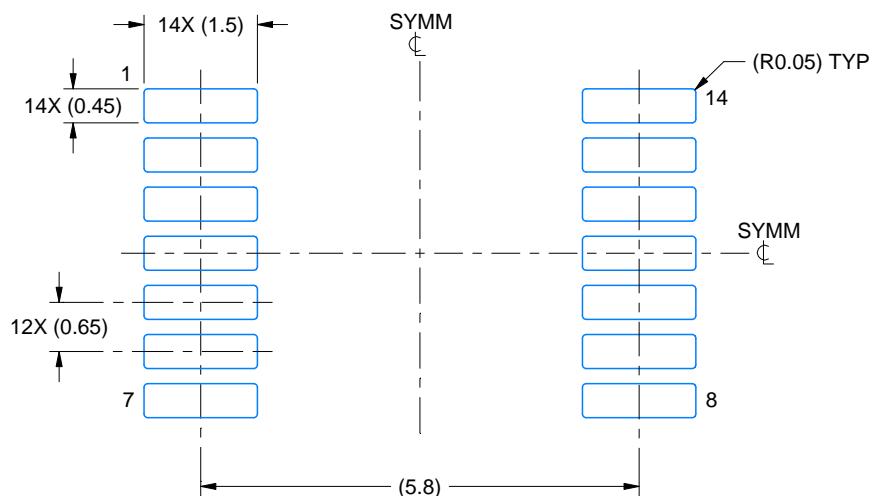
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

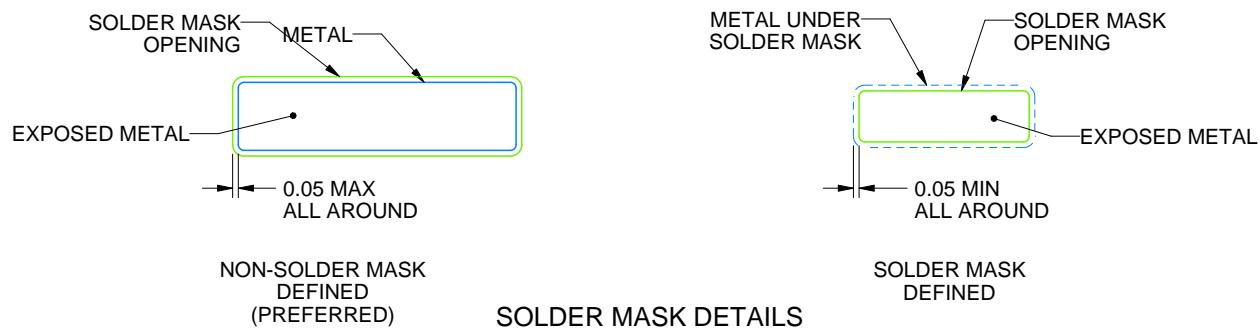
PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



4220202/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

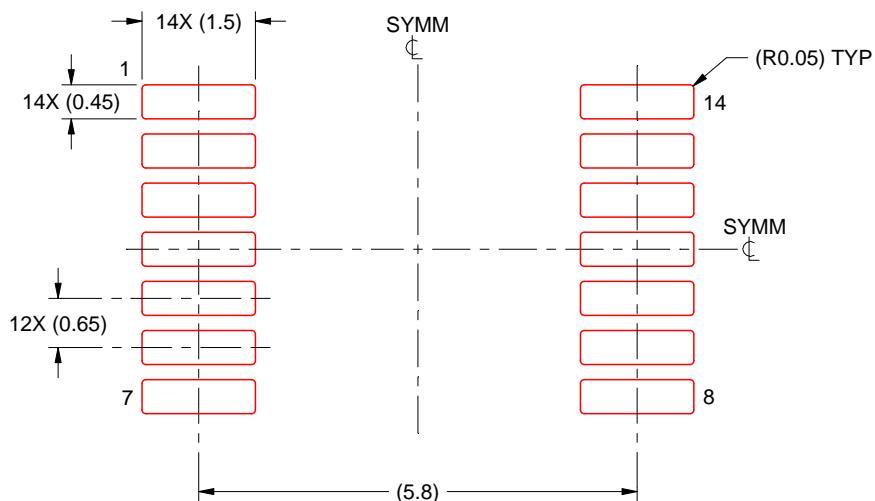
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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